MICROCHIP

Product Change Notification: DSNO-09GUUD527

Date:

11-Dec-2025

Product Category:

Memory

Notification Subject:

CCB 7830 Initial Notice: Qualification of MMT as an additional assembly site for selected SST26WF016B, SST26WF016BA, SST26WF080B, SST26WF080BA, SST26WF040B, SST26WF040BA, SST26VF032B, SST26VF032BA, SST26WF064C, SST26VF064BEUI, SST26VF016B, SST26VF080A, SST26VF040A, SST26VF020A, SST25VF080B, SST25VF020B, SST25VF040B, SST26VF064B, SST26VF064BA and SST25PF020B device families available in 8L WSON (6x5x0.8mm) package.

Affected CPNs:

DSNO-09GUUD527_Affected_CPN_12112025.pdf
DSNO-09GUUD527_Affected_CPN_12112025.csv

PCN Status: Initial Notification

PCN Type: Manufacturing Change

Microchip Parts Affected: Please open one of the files found in the Affected CPNs section.
Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change: Qualification of MMT as an additional assembly site for selected SST26WF016B, SST26WF016BA, SST26WF080B, SST26WF080BA, SST26WF040B, SST26WF040BA, SST26VF032B, SST26VF032BA, SST26WF064C, SST26VF064BEUI, SST26VF016B, SST26VF080A, SST26VF040A, SST26VF020A, SST25VF080B, SST25VF020B, SST25VF040B, SST26VF064B, SST26VF064BA and SST25PF020B device families available in 8L WSON (6x5x0.8mm) package.

Pre and Post Summary Changes:

	Pre Change	Post Change	Change (Yes/No)

Assembly Site	UTAC Thai Limited (UTL-1) (NSEB)	UTAC Thai Limited (UTL-3)	UTAC Thai Limited (UTL-1) (NSEB)	UTAC Thai Limited (UTL-3)	Microchip Technology Thailand (Branch) (MMT)	Yes
Wire Material	CuPdAu	CuPdAu	CuPdAu	CuPdAu	CuPdAu	No
Die Attach Material	558-2C31 (PFAS Free)	558-2C31 (PFAS Free)	558-2C31 (PFAS Free)	558-2C31 (PFAS Free)	QMI519 (PFAS Free)	Yes
Molding Compound Material	G700LTD	G700LTD	G700LTD	G700LTD	G700LTD	No
Lead-Frame Material	C194	C194	C194	C194	A194	No
Lead-Frame Design	See Pre and Post Change Summary attachment for comparison.					

Note: C194, A194 or CDA194 Lead frame material are the same, it is just a MCHP internal labelling difference.

Impacts to Datasheet: None

Change Impact: None

Reason for Change: To improve on-time delivery performance by qualifying MMT as an additional assembly site.

Change Implementation Status: In Progress

Estimated Qualification Completion Date: January 2026

Note: Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and a final PCN has been issued. The final PCN will include the qualification report and estimated first ship date. Also note that after the estimated first ship date guided in the final PCN customers may receive pre and post change parts.

Timetable Summary:

	December 2025				>	**January 2026**				
Work Week	49	50	51	52		01	02	03	04	05
Initial PCN Issue Date		X								
Qual Report Availability									X	

Final PCN Issue Date										X	

Method to Identify Change: Traceability Code

Qualification Plan: Please open the attachments included with this PCN labeled as PCN_#_Qual_Plan.

Revision History: December 11, 2025: Issued initial notification.

Note: The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable product.

Attachments:

PCN_DSNO-09GUUD527_Pre_and_Post Change Summary.pdf
PCN_DSNO-09GUUD527_Qual_Plan.pdf

Please contact your local **Microchip sales office** with questions or concerns regarding this notification.

Terms and Conditions:

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